

TOSHIBA THYRISTOR SILICON DIFFUSED TYPE

SF10G41A, SF10J41A

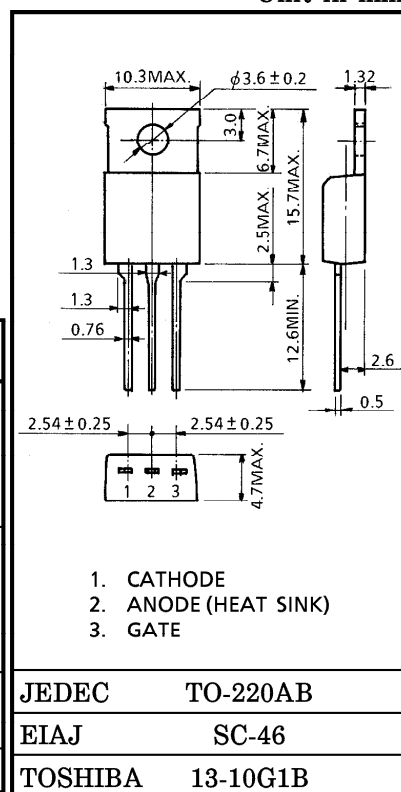
MEDIUM POWER CONTROL APPLICATIONS.

Unit in mm

- Repetitive Peak Off-State Voltage : V_{DRM} } = 400, 600V
Repetitive Peak Reverse Voltage : V_{RRM} }
- Average On-State Current : $I_{T(AV)} = 10A$
- Gate Trigger Current : $I_{GT} = 15mA (MAX.)$

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	SF10G41A	400	V
	SF10J41A	600	
Non-Repetitive Peak Reverse Voltage (Non-Repetitive < 5ms, $T_j = 0 \sim 125^\circ C$)	SF10G41A	500	V
	SF10J41A	720	
Average On-State Current (Half Sine Waveform $T_c = 79^\circ C$)	$I_{T(AV)}$	10	A
R.M.S On-State Current	$I_{T(RMS)}$	16	A
Peak One Cycle Surge On-State Current (Non-Repetitive)	I_{TSM}	160 (50Hz)	A
		176 (60Hz)	
I^2t Limit Value ($t = 1 \sim 10ms$)	I^2t	125	A^2s
Critical Rate of Rise of On-State Current	di/dt	100	$A/\mu s$
Peak Gate Power Dissipation	P_{GM}	5	W
Average Gate Power Dissipation	$P_{G(AV)}$	0.5	W
Peak Forward Gate Voltage	V_{FGM}	10	V
Peak Reverse Gate Voltage	V_{RGM}	-5	V
Peak Forward Gate Current	I_{GM}	2	A
Junction Temperature	T_j	-40~125	$^\circ C$
Storage Temperature Range	T_{stg}	-40~125	$^\circ C$



Weight : 2g

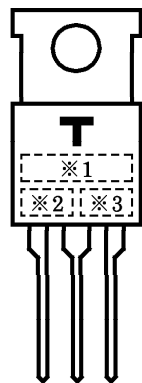
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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	I_{DRM} I_{RRM}	$V_{DRM}=V_{RRM}=\text{Rated}$	—	10	μA
Peak On-State Voltage	V_{TM}	$I_{TM}=30\text{A}$	—	1.6	V
Gate Trigger Voltage	V_{GT}	$V_D=6\text{V}, R_L=10\Omega$	—	1.0	V
Gate Trigger Current	I_{GT}		—	15	mA
Gate Non-Trigger Voltage	V_{GD}	$V_D=\text{Rated}\times 2/3, T_c=125^\circ\text{C}$	0.2	—	V
Critical Rate of Rise of Off-State Voltage	dv/dt	$V_{DRM}=\text{Rated}\times 2/3, T_c=125^\circ\text{C}$ Exponential Rise	100	—	$\text{V}/\mu\text{s}$
Holding Current	I_H	$V_D=6\text{V}, I_{TM}=1\text{A}$	—	40	mA
Latching Current	I_L	$V_D=6\text{V}, f=50\text{Hz}, t_{gw}=50\mu\text{s}$ $i_G=30\text{mA}$	—	60	mA
Thermal Resistance	$R_{th(j-c)}$	Junction to Case	—	2.0	$^\circ\text{C}/\text{W}$

MARK

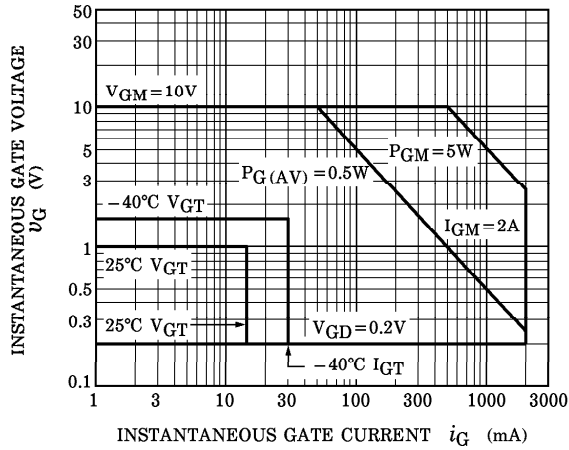


NUMBER	SYMBOL		MARK
※1	TYPE	SF10G41A	SF10G41
		SF10J41A	SF10J41
※2		SF10G41A, SF10J41A	A
※3	Lot Number □ □ Month (Starting from) (Alphabet A) Year (Last Number of the Christian Era)		Example 2A : January 1992 2B : February 1992 2L : December 1992

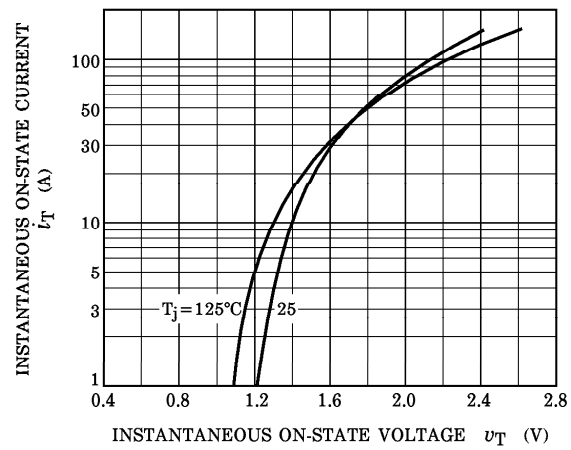
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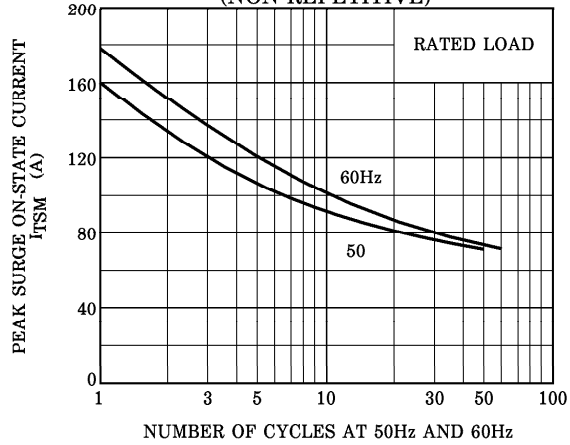
GATE TRIGGER CHARACTERISTIC



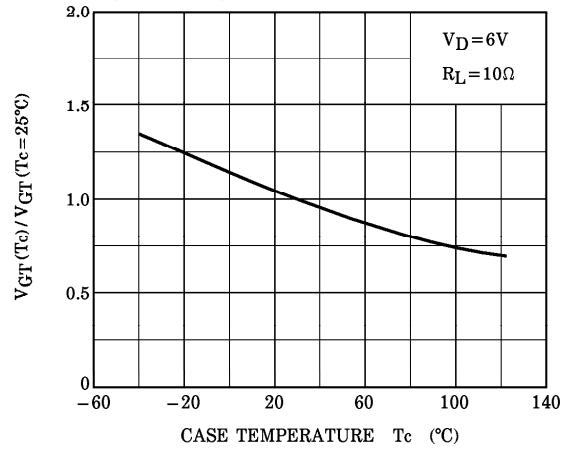
$i_T - v_T$



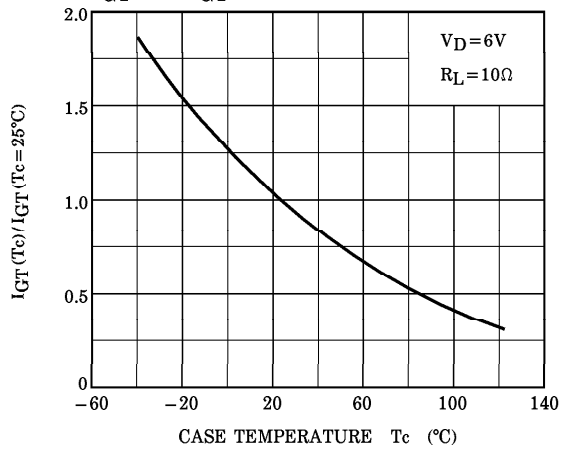
SURGE ON-STATE CURRENT (NON-REPETITIVE)



$V_{GT}(T_c) / V_{GT}(T_c = 25^\circ C) - T_c$ (TYPICAL)



$I_{GT}(T_c) / I_{GT}(T_c = 25^\circ C) - T_c$ (TYPICAL)



$I_H(T_c) / I_H(T_c = 25^\circ C) - T_c$ (TYPICAL)

